# XRD5410

5V, Low Power, Voltage Output Serial 10-bit DAC

May 1997-5

**F(**ø)

## **FEATURES**

- 10-Bit Resolution
- Operates from a Single 5V Supply
- Buffered Voltage Output •
- 240µW Total Power Consumption (typ)
- Guaranteed Monotonic Over Temperature •

**XPEXAR** ... the analog plus company<sup>TM</sup>

- Flexible Output Range: 0V to V<sub>DD</sub>
- 8 Lead SOIC and PDIP Package
- Power On Reset
- Serial Data Output for Daisy Chaining

## **APPLICATIONS**

- **Digital Calibration** •
- **Battery Operated Instruments**
- **Remote Industrial Devices**
- **Cellular Telephones**
- Motion Control

## **GENERAL DESCRIPTION**

The XRD5410 is a low power, voltage output digital-to-analog converter (DAC) for +5V power supply operation. The part draws only 70µA of quiescent current and is available in both an 8 lead PDIP and SOIC package.

The XRD5410 has a 3 wire serial port with an output

## **ORDERING INFORMATION**

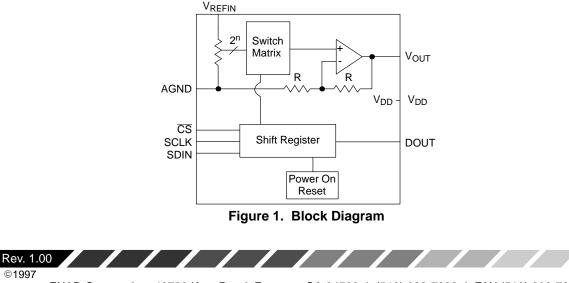
allowing the user to daisy chain several of them together. The serial port will support both Microwire<sup>TM</sup>, SPI<sup>TM</sup>, and QSPI<sup>™</sup> standards.

The output of the XRD5410 is set at a gain of +2 and is capable of swinging rail-to-rail. The output short circuit is 12mA typical.

Part No.	Package	Operating Temperature Range
XRD5410AID	8 Lead 150 Mil JEDEC SOIC	-40°C to +85°C
XRD5410AIP	8 Lead 300 Mil PDIP	-40°C to +85°C

## **BLOCK DIAGRAM**

©1997

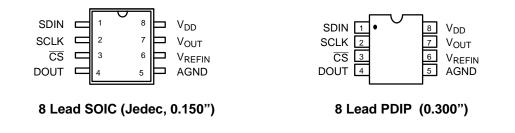


EXAR Corporation, 48720 Kato Road, Fremont, CA 94538 ♦ (510) 668-7000 ♦ FAX (510) 668-7017





#### **PIN CONFIGURATION**



#### **PIN DESCRIPTION**

Pin #	Symbol	Description
1	SDIN	Serial Data Input
2	SCLK	Serial Data Clock
3	CS	Chip Select (Active High)
4	DOUT	Serial Data Output
5	AGND	Analog Ground
6	V <sub>REFIN</sub>	Voltage Reference Input
7	V <sub>OUT</sub>	DAC Output
8	V <sub>DD</sub>	Supply Voltage







#### **ELECTRICAL CHARACTERISTICS**

Test Conditions:  $V_{DD}$ = 5V, GND= 0V,  $V_{REFIN}$ = 2.048V (External),  $R_L$ = 10k $\Omega$ ,  $C_L$ = 100pF,  $T_A$ =  $T_{MIN}$  to  $T_{MAX}$ , Unless Otherwise Noted.

Symbol	Parameter	Min.	Тур.	Max.	Unit	Conditions	
Static Performance							
N	Resolution	10			Bits		
INL	Relative Accuracy		0.5	1	LSB		
DNL	Differential Nonlinearity		0.25	0.5	±LSB	Guaranteed Monotonic	
V <sub>OS</sub>	Offset Error	0	3	8	mV		
TCV <sub>OS</sub>	Offset Tempco		2		ppm/°C		
PSRR	Offset-Error Power-Supply Rejection Ratio		0.5	1	mV	$4.5V \leq V_{DD} \leq 5.5V$	
GE	Gain Error		0.1	0.4	%FS		
TCGE	Gain-Error Tempco		10		ppm/°C		
PSRR	Power-Supply Rejection Ratio		0.1	1	mV	$\rm 4.5V{\le}V_{DD}{\le}$ 5.5V, Measured at FS	
Voltage Out	put (V <sub>OUT</sub> )	•		•	•	•	
Vo	Output Voltage Range	0		V <sub>DD</sub> -0.4	V		
V <sub>REG</sub>	Output Load Regulation		2	4	mV	$V_{OUT} = 2V, R_L = 2k\Omega$	
+I <sub>SC</sub>	Short-Circuit Current, Sink		13		mA	V <sub>OUT</sub> = V <sub>DD</sub>	
-I <sub>SC</sub>	Short-Circuit Current, Source		7		mA	V <sub>OUT</sub> = GND	
Voltage Ref	erence Input (V <sub>REFIN</sub> )	•		1	•	•	
V <sub>REFIN</sub>	Voltage Range	0		V <sub>DD</sub>	V	Output Swing Limited, Not Code Dependent	
R <sub>IN</sub>	Input Resistance	40	65		kΩ		
TCR <sub>IN</sub>	Input Resistance Tempco		1500		ppm/°C		
C <sub>IN</sub>	Input Capacitance		32	40	pF	Not Code Dependent	
AC <sub>FT</sub>	AC Feedthrough		-80		dB	REFIN = 1kHz, 2Vp-p, SD <sub>IN</sub> =000h	
Digital Input	ts (SDIN, SCLK, CS)		•	•		•	
V <sub>IH</sub>	Input High	3.5			V		
VIL	Input Low			1	V		
I <sub>IN</sub>	Input Current			± 1	μA	V <sub>IN</sub> =0V or V <sub>DD</sub>	
C <sub>IN</sub>	Input Capacitance		10		pF		
Digital Outp	ut (DOUT)		•	•		•	
V <sub>OH</sub>	Output High	V <sub>DD</sub> -1			V	I <sub>SOURCE</sub> =4mA	
V <sub>OL</sub>	Output Low			0.4	V	I <sub>SINK</sub> =4mA	
Dynamic Pe	rformance	-	-	-		•	
SR	Voltage-Output Slew Rate	0.15	0.21		V/µs	T <sub>A</sub> =+25°C	
t <sub>s</sub>	Voltage-Output Settling Time		13		μs	$\pm$ 1/2LSB, V <sub>OUT</sub> =2V	





## ELECTRICAL CHARACTERISTICS (CONT'D)

Symbol	Parameter	Min.	Тур.	Max.	Unit	Conditions
D <sub>FT</sub>	Digital Feedthrough		1		nV-s	CS=V <sub>DD</sub> , SDIN=SCLK=100kHz
SINAD	Signal-to-Noise Plus Distortion		-68		dB	V <sub>REFIN</sub> =1kHz, 2Vp-p F.S., SDIN=Full Scale, –3dB BW =250kHz
Power Supp	bly					•
V <sub>DD</sub>	Positive Supply Voltage	4.5		5.5	V	
I <sub>DD</sub>	Power Supply Current		35	50	μΑ	All Inputs=0V or V <sub>DD</sub> , Output=no load, I <sub>REF</sub> not included
Switching C	haracteristics		•	•	•	•
t <sub>CSS</sub>	CS Setup Time	10	20		ns	
t <sub>CSH0</sub>	SCLK Fall to $\overline{CS}$ Fall Hold Time	5			ns	
t <sub>CSH1</sub>	SCLK Fall to $\overline{CS}$ Rise Hold Time	0			ns	
t <sub>CH</sub>	SCLK High Width	20	35		ns	
t <sub>CL</sub>	SCLK Low Width	20	35		ns	
t <sub>DS</sub>	D <sub>IN</sub> Setup Time	10	45		ns	
t <sub>DH</sub>	D <sub>IN</sub> Hold Time	0			ns	
t <sub>DO</sub>	D <sub>OUT</sub> Valid Propagation Delay		8	15	ns	C <sub>L</sub> = 50pF
t <sub>CSW</sub>	CS High Pulse Width	20	40		ns	
t <sub>CS1</sub>	CS Rise to SCLK Rise Setup Time	10	20		ns	

Specifications are subject to change without notice

#### **ABSOLUTE MAXIMUM RATINGS**

$V_{\text{DD}}$ to GND $\ldots \ldots \ldots$
Digital Input Voltage to GND $\ldots$ -0.3V, V <sub>DD</sub> +0.3V
V <sub>REFIN</sub>
$V_{OUT}^1$ $V_{DD}$ , GND
Continuous Current, Any Pin20mA, +20mA

Package Power Dissipation Ratings ( $T_A$ = +70°C) PDIP (derate 9mW/°C above +70°C) ... 117mW SOIC (derate 6mW/°C above +70°C) ... 155mW Operating Temperature Range ..... -40°C to + 85°C Storage Temperature Range ..... -65°C to +165°C Lead Temperature (soldering, 10 sec) ..... +300°C

#### Notes

<sup>1</sup> Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation at or above this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

<sup>2</sup> Any input pin which can see a value outside the absolute maximum ratings should be protected by Schottky diode clamps (HP5082-2835) from input pin to the supplies. All inputs have protection diodes which will protect the device from short transients outside the supplies of less than 100mA for less than 100µs.





## TIMING

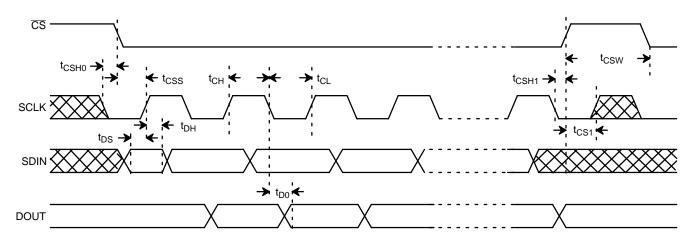


Figure 2. Timing Diagram

	Input		Output
1111	1111	11(00)	$+ 2 (V_{REFIN}) \frac{1023}{1024}$
1000	0000	01(00)	$+ 2 (V_{REFIN}) \frac{513}{1024}$
1000	0000	00(00)	$+ 2 (V_{REFIN}) \frac{512}{1024} = + V_{REFIN}$
0111	1111	11(00)	$+ 2 (V_{REFIN}) \frac{511}{1024}$
0000	0000	01(00)	$+ 2 (V_{REFIN}) \frac{1}{1024}$
0000	0000	00(00)	0V

#### Note

Write 10-bit data words with two sub-LSB 0s because the DAC input latch is 12 bits wide.

#### Table 1. Binary Code Table





## THEORY OF OPERATION

## XRD5408/10/12 Description

The XRD5408/10/12 are micro-power, voltage output, serial daisy-chain programmable DACs operating from a single 5V power supply. The DACs are built on a 0.6 micron CMOS process. The features of these DACs make it well suited for industrial control, low distortion audio, battery operated devices and cost sensitive designs that want to minimize pin count on ICs.

## **Resistor String DAC**

A resistor string architecture converts digital data using a switch matrix to an analog signal as shown in *Figure 3*.

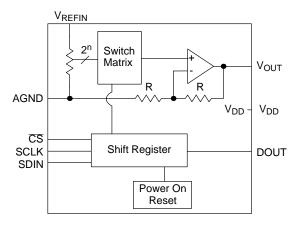


Figure 3. XRD5408/10/12 DAC Architecture

The resistor string architecture provides a non-inverted output voltage ( $V_{OUT}$ ) of the reference input ( $V_{REFIN}$ ) for single supply operation while maintaining a constant input resistance. Unlike inverted R-2R architectures the reference input resistance will remain constant independent of code. This greatly simplifies the analog driving source requirements for the reference voltage and minimizes distortion. Similarly input capacitance varies only approximately 4pF over all codes.

## Fixed Gain +2 Voltage Output Amplifier

A high open-loop gain operational amplifier buffers the resistor string with a stable, fixed gain of +2. The voltage output swings from rail-to-rail while settling within  $13\mu$ s. The output is short circuit protected and can regulate an output load of 2V into  $2k\Omega$  within 2mV at  $25^{\circ}$ C.

While the reference input will accept a voltage from rail-to-rail, the linear input voltage range is constrained by the output swing of the fixed +2 closed-loop gain amplifier. Full scale output swing is achieved with an external reference of approximately  $1/2 V_{DD}$ . The reference voltage must be positive because the XRD5408/10/12 DAC is non-inverting.

## Serial Daisy-Chainable Digital Interface

The three wire serial interface includes a DOUT to enable daisy-chaining of several DACs. This minimizes pin count necessary of digital asics or controllers to address multiple DACS. The serial interface is designed for CMOS logic levels. Timing is shown in *Figure 2*. The binary coding table (*Table 1*) shows the DAC transfer function.

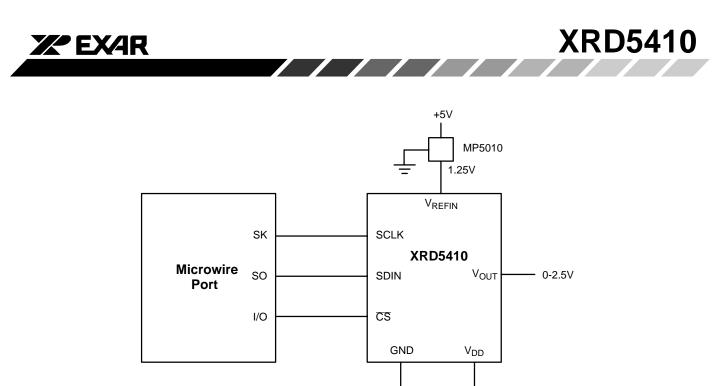
A power on reset circuit forces the DAC to reset to all "0"s on power up.

## **APPLICATION NOTES**

## **Serial Interface**

The XRD5408/10/12 family has a three wire serial interface that is compatible with Microwire TM, SPI TM and QSPI TM standards. Typical configurations are shown in *Figure 4 and Figure 5*. Maximum serial port clock rate is limited by the minimum pulse width of  $t_{CH}$  and  $t_{CL}$ . Feedthrough noise from the serial port to the analog output (V<sub>OUT</sub>) is minimized by lowering the frequency of the serial port and holding the digital edges to >5ns.







÷

┨┠

0.1μF

+5V

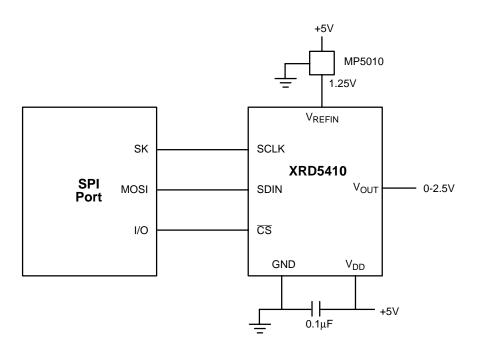


Figure 5. Typical Microwire Application Circuit





The DACs are programmed by a 16 bit word of serial data. The first leading 4 bits are not used to update the DAC. If the DAC is not daisy-chained then only a 12 bit serial word is needed to program the DAC. The next 8, 10 or 12 bits after the 4 leading bits are data bits. The XRD5408's first 8 bits are valid data and the trailing 4 bits must be set to 0. The XRD5410's first 10 bits are valid data and the trailing 2 bits must be set to 0. *Table 2* demonstrates the 16 bit digital word for the 8, 10 and 12 bit DACs.

Part	Leading Unused Bits	Data Bits MSB LSB	Trailing "0" Bits
XRD5412	XXXX	XXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXX	None
XRD5410	XXXX	XXXXXXXXXX	00
XRD5408	XXXX	XXXXXXXX	0000

## Table 2 16 Bit Digital Word Register for XRD5408, XRD5410, XRD5412

SCLK should be held low when  $\overline{CS}$  transitions low. Data is clocked in on the rising edge of SCLK when  $\overline{CS}$  is low. SDIN data is held in a 16 bit serial shift register. The DAC is updated with the data bits on the rising edge of  $\overline{CS}$ . When  $\overline{CS}$  is high data is not shifted into the XRD5408/10/12.

## **Daisy-Chaining**

The digital output port (DOUT) has a 4mA drive for greater fan-out capability when daisy-chaining. DOUT allows cascading of multiple DACs with the same serial data stream. The data at SDIN appears at DOUT after 16 clock cycles plus one clock width ( $t_{CH}$ ) and a propagation delay ( $t_{DO}$ ). DOUT remains in the state of the last data bit when  $\overline{CS}$  is high. DOUT changes on the falling edge of SCLK when  $\overline{CS}$  is low.

Any number of DACs can be connected in this way by connecting DOUT of one DAC to SDIN of the next DAC.

#### AC<sub>FT</sub> Feedthrough (DAC Code = 0)

AC Feedthrough from  $V_{REFIN}$  to  $V_{OUT}$  is minimized with low impedance grounding as shown in *Figure 6*. If the DAC data is set to all "0"s then  $V_{OUT}$  is a function of the divider between the DAC string impedance and ground impedance. See the Power Supply and Grounding section for recommendations. The typical AC feedthrough for a 1kHz 2Vpp signal with code = 0 is -80dB.



\_ \_ \_ \_ \_ \_ /

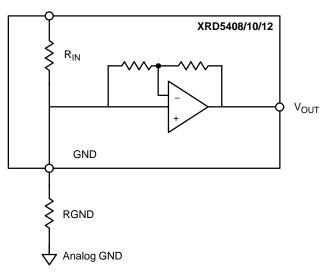


Figure 6. AC<sub>FT</sub> Feedthrough Equivalent Circuit, DAC Code =0

#### Compatible with MAX515 & MAX539

The XRD5408/10/12 family of DACs are functionally compatible with the MAX515 & MAX539 while providing significant improvements. The XRD5408/10/12 DACs have lower power, faster serial ports, and a constant reference impedance to minimize the reference driving requirements and maximize system linearity. The DOUT port has 4mA driving capability for greater fan-out when daisy-chaining to other digital inputs.

#### Monotonicity

The XRD5408/10/12 family of DACs are monotonic over the entire temperature range.

#### **Micro-Power Operation**

The XRD5408/10/12 family are the lowest power in their class. The quiescent current rating does not include the reference ladder current. Power can be saved when the part is not in use by setting the DAC code to all "0"s assuming the output load is referenced to ground. This minimizes the DAC output load current. An analog switch placed in series with the reference ladder can toggle the reference voltage off when the circuit is inactive to minimize power consumption.





#### **Power Supply and Grounding**

Best parametric results are obtained by powering the XRD5408/10/12 family of DACs from an analog +5V power supply and analog ground. Digital power supplies and grounds should be separated or connected to the analog supplies and grounds only at the low-impedance power-supply source. This is best accomplished on a multilayer PCB with dedicated planes to ground and power. The DACs should be locally bypassed with both  $0.1\mu$ F and  $2.2\mu$ F capacitors mounted as close as possible to the power supply pin (V<sub>DD</sub>). Surface mount ceramic capacitors are recommended for low impedance, wide band power supply bypass. If only one +5V power supply is available for both analog and digital circuity isolate the analog power supply to the XRD5408/10/12 DAC with an inductor or ferrite bead before the local bypass capacitors.

#### **PERFORMANCE CHARACTERISTICS**

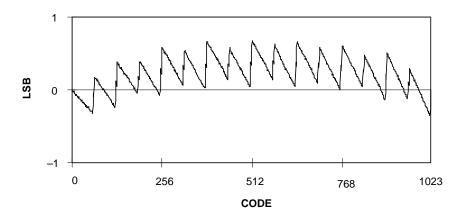


Figure 7. XRD5410 INL

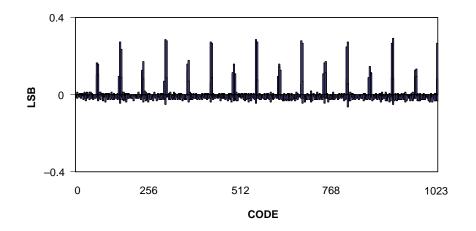
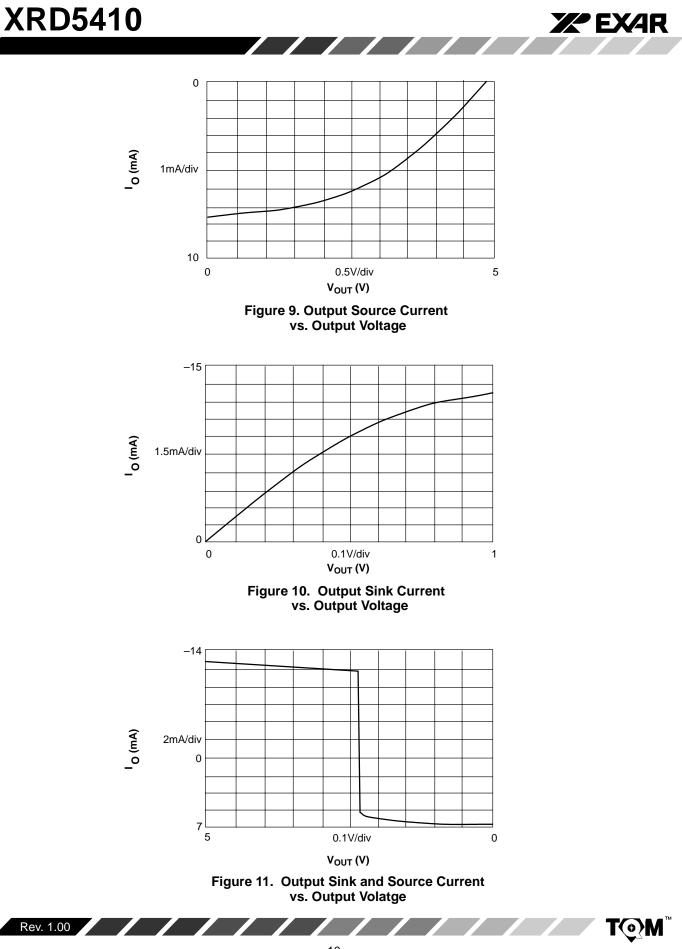
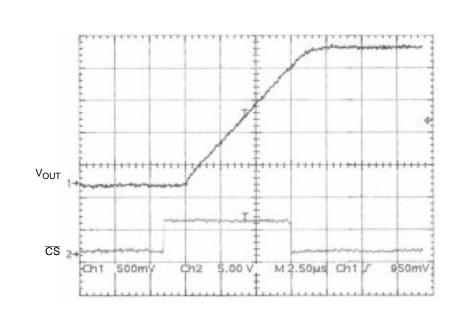


Figure 8. XRD5410 DNL







**XPEXAR** 

**XRD5410** 

Figure 12. Voltage Output Settling Time (t<sub>s</sub>),  $V_{DD}$  = 5V,  $V_{REFIN}$  = 1V, No Load

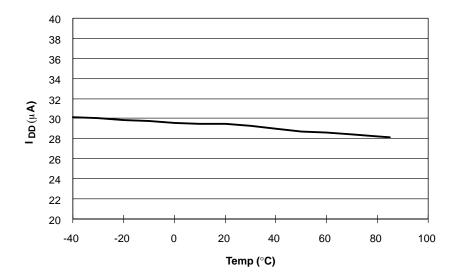


Figure 13. I<sub>DD</sub> vs. Temperature





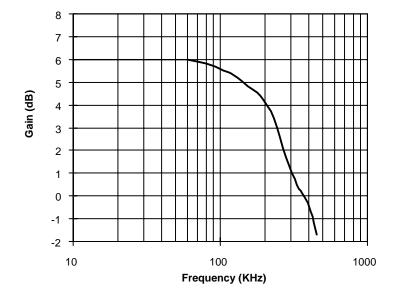


Figure 14. Closed Loop Gain vs. Frequency

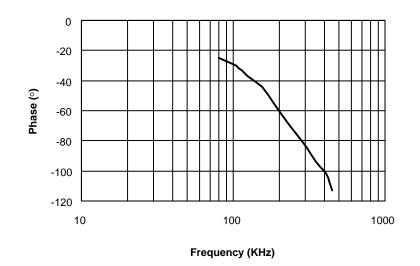


Figure 15. Closed Loop Phase vs. Frequency

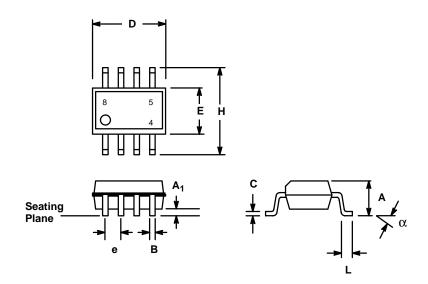






8 LEAD SMALL OUTLINE (150 MIL JEDEC SOIC)

Rev. 1.00



	INC	HES	MILLIN	IETERS
SYMBOL	MIN	MAX	MIN	МАХ
А	0.053	0.069	1.35	1.75
A <sub>1</sub>	0.004	0.010	0.10	0.25
В	0.013	0.020	0.33	0.51
С	0.007	0.010	0.19	0.25
D	0.189	0.197	4.80	5.00
E	0.150	0.157	3.80	4.00
е	0.0	50 BSC	1.2	7 BSC
Н	0.228	0.244	5.80	6.20
L	0.016	0.050	0.40	1.27
α	0°	8°	0°	8°

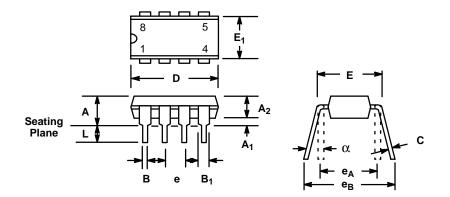
Note: The control dimension is the millimeter column





## 8 LEAD PLASTIC DUAL-IN-LINE (300 MIL PDIP)

Rev. 1.00



	INC	HES	MILLIN	IETERS
SYMBOL	MIN	MAX	MIN	МАХ
А	0.145	0.210	3.68	5.33
A <sub>1</sub>	0.015	0.070	0.38	1.78
A <sub>2</sub>	0.015	0.195	2.92	4.95
В	0.014	0.024	0.36	0.56
B <sub>1</sub>	0.030	0.070	0.76	1.78
С	0.008	0.014	0.20	0.38
D	0.348	0.430	8.84	10.92
E	0.300	0.325	7.62	8.26
E <sub>1</sub>	0.240	0.280	6.10	7.11
е	0.1	00 BSC	2.5	4 BSC
e <sub>A</sub>	0.3	00 BSC	7.6	2 BSC
e <sub>B</sub>	0.310	0.430	7.87	10.92
L	0.115	0.160	2.92	4.06
α	0°	$15^{\circ}$	0°	15 <sup>°</sup>

Note: The control dimension is the inch column





Notes





## NOTICE

EXAR Corporation reserves the right to make changes to the products contained in this publication in order to improve design, performance or reliability. EXAR Corporation assumes no responsibility for the use of any circuits described herein, conveys no license under any patent or other right, and makes no representation that the circuits are free of patent infringement. Charts and schedules contained here in are only for illustration purposes and may vary depending upon a user's specific application. While the information in this publication has been carefully checked; no responsibility, however, is assumed for inaccuracies.

EXAR Corporation does not recommend the use of any of its products in life support applications where the failure or malfunction of the product can reasonably be expected to cause failure of the life support system or to significantly affect its safety or effectiveness. Products are not authorized for use in such applications unless EXAR Corporation receives, in writing, assurances to its satisfaction that: (a) the risk of injury or damage has been minimized; (b) the user assumes all such risks; (c) potential liability of EXAR Corporation is adequately protected under the circumstances.

All trademarks and registered trademarks are property of their respective owners.

Copyright 1997 EXAR Corporation Datasheet May 1997 Reproduction, in part or whole, without the prior written consent of EXAR Corporation is prohibited.

